

TMS320VC5409A

Fixed-Point Digital Signal Processor

Data Manual



PRODUCTION DATA information is current as of publication date.
Products conform to specifications per the terms of the Texas
Instruments standard warranty. Production processing does not
necessarily include testing of all parameters.

Literature Number: SPRS140G
November 2000—Revised October 2008

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

This data sheet revision history highlights the technical changes made to the SPRS140F device-specific data sheet to make it an SPRS140G revision.

Scope: This document has been reviewed for technical accuracy; the technical content is up-to-date as of the specified release date with the following corrections.

ADDITIONS/CHANGES/DELETIONS
Table 2-2 . Signal Descriptions: • Updated DESCRIPTION of $\overline{\text{TRST}}$ • Added footnote about $\overline{\text{TRST}}$

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